

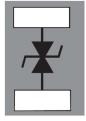
ESDZV201-1BF4

Datasheet

20 V low clamping, low capacitance single line bidirectional ESD protection



0201 package



Features

- Low clamping voltage: 31 V at 16 A I_{PP} TLP
- Bidirectional device
- Stand-off voltage: 20 V
- 0201 thin package PCB area: 0.18 mm²
- Complies with the following standards: IEC 61000-4-2 level 4
 - ±15 kV (air discharge)
 - ±8 kV (contact discharge)
- ECOPACK2 compliant component

Application

Where transient over voltage protection in ESD sensitive equipment is required, such as:

- Smartphones, mobile phones and accessories
- Tablet and notebooks
- Portable multimedia devices and accessories
- Wearable, home automation, healthcare
- Highly integrated systems

Product status link ESDZV201-1BF4

Description

The ESDZV201-1BF4 is a bidirectional single line TVS diode designed to protect the data line or other I/O ports against ESD transients.

The device is ideal for applications where both reduced line capacitance and board space saving are required.

1 Characteristics

Symbol		Value	Unit	
V	Peak pulse voltage	IEC 61000-4-2 contact discharge	±8	kV
V _{pp}		IEC 61000-4-2 air discharge	±15	
P _{pp}	Peak pulse power (8/20 µs)		140	W
I _{pp}	Peak pulse current (8/20 µs)		4.5	А
Tj	Operating junction temperature range		-55 to +150	
T _{stg}	Storage junction temperature range		-65 to +150	°C
TL	Maximum lead temperature fo	260		

Table 1. Absolute maximum ratings (T_{amb} = 25 °C)

Figure 1. Electrical characteristics (definitions)

Symbol		Parameter
V _{Trig}	=	Trigger voltage
V _{CL}	=	Clamping voltage
I _{RM}	=	Leakage current @V _{RM}
V_{RM}	=	Stand-off voltage
I _{PP}	=	Peak pulse current
R_{D}	=	Dynamic resistance
V _H	=	Holding voltage
$\boldsymbol{C}_{\text{LINE}}$	=	Input capacitance per line

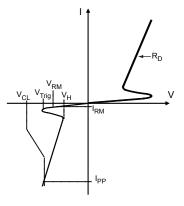


Table 2. Electrical characteristics (values) (T_{amb} = 25° C)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
V _{trig}	Higher voltage than V_{TRIG} guarantees the protection turn-on		23		30	V
V _H	Lower voltage than V_{H} guarantees the protection turn-off		20			V
I _{RM}	Leakage current	V _{RM} = 20 V			0.3	μA
I _R	V = 18 V				100	nA
V _{CL}	Clamping voltage	IEC 61000-4-2, 8 kV contact discharge measured after 30 ns		30		V
V _{CL}	8/20 μs waveform, I _{PP} = 1 A			22	10	V
V _{CL}	$8/20 \ \mu s$ waveform, I_{PP} = 4.5 A			29	31	V
R _D	Dynamic resistance, pulse duration 100 ns - IPP [1 A - 16 A]			0.7		Ω
C _{LINE}	Line capacitance	V _{LINE} = 0 V, F = 1 MHz, V _{OSC} = 30 mV		3	5	pF



1.1 Characteristics (curves)

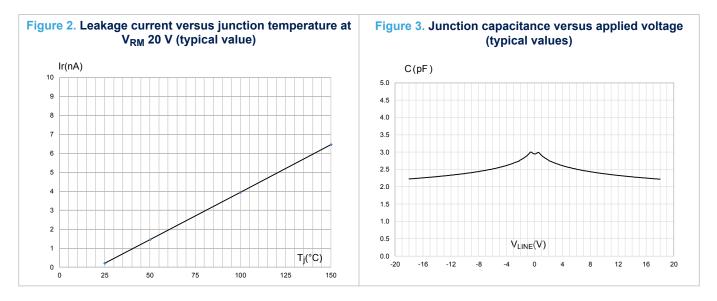
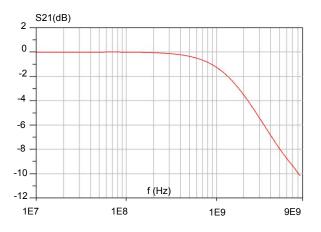
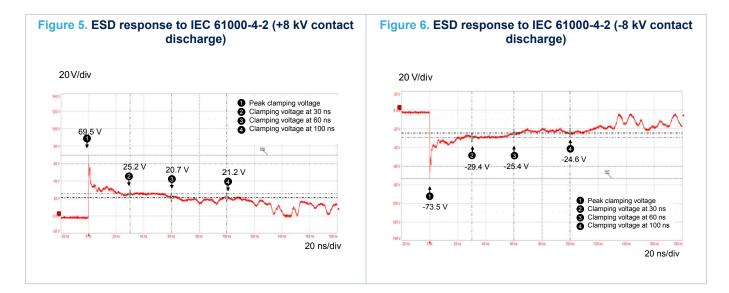
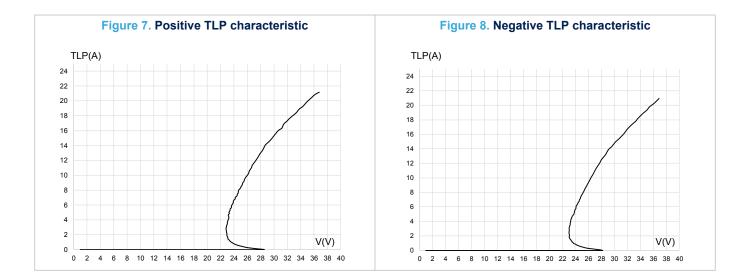


Figure 4. S21 attenuation







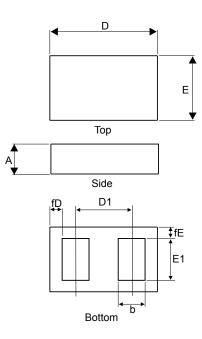


Package information 2

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 0201 package information

Figure 9. 0201 package outline



The marking codes can be rotated by 90° or 180° to differentiate assembly location. In no case should this Note: product marking be used to orient the component for its placement on a PCB. Only pin 1 mark is to be used for this purpose.

Table 3. 0201 package mechanical data

		Dimensions				
Ref.	Millimeters					
	Min.	Тур.	Max.			
A	0.130	0.150	0.170			
b	0.1675	0.1875	0.2075			
D	0.560	0.580	0.600			
D1		0.3375				
E	0.260	0.280	0.300			
E1	0.205	0.225	0.245			
fD	0.0175	0.0275	0.0375			
fE	0.0175	0.0275	0.0375			

Figure 10. Tape and reel specification

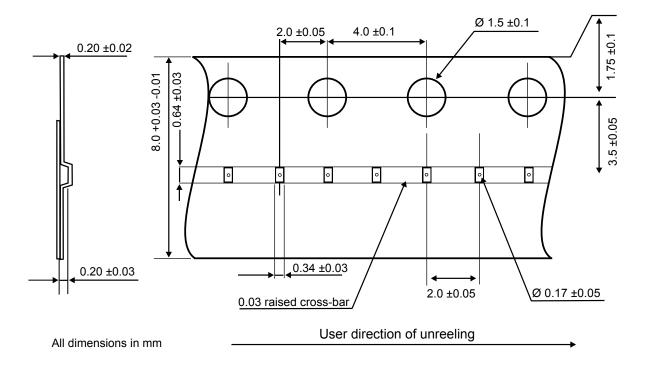


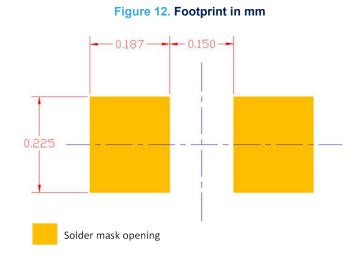
Figure 11. Marking



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3 Recommendation PCB assembly

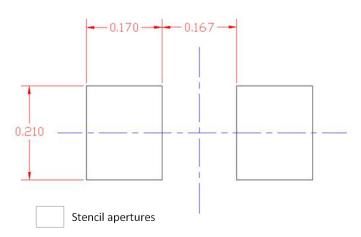
3.1 Footprint



3.2 Stencil opening design

- 1. Recommended design reference
 - a. Stencil opening dimensions: 75 µm / 3 mils

Figure 13. Stencil opening recommendations



3.3 Solder paste

- 1. Halide-free flux qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste is recommended.
- 3. Offers a high tack force to resist component movement during high speed.
- 4. Use solder paste with fine particles: powder particle size 20-38 $\mu m.$

3.4 Placement

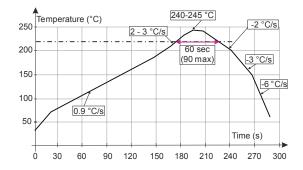
- 1. Manual positioning is not recommended.
- 2. It is recommended to use the lead recognition capabilities of the placement system, not the outline centering
- 3. Standard tolerance of ±0.05 mm is recommended.
- 4. 1.0 N placement force is recommended. Too much placement force can lead to squeezed out solder paste and cause solder joints to short. Too low placement force can lead to insufficient contact between package and solder paste that could cause open solder joints or badly centered packages.
- 5. To improve the package placement accuracy, a bottom side optical control should be performed with a high resolution tool.
- 6. For assembly, a perfect supporting of the PCB (all the more on flexible PCB) is recommended during solder paste printing, pick and place and reflow soldering by using optimized tools.

3.5 PCB design preference

- 1. To control the solder paste amount, the closed via is recommended instead of open vias.
- 2. The position of tracks and open vias in the solder area should be well balanced. A symmetrical layout is recommended, to avoid any tilt phenomena caused by asymmetrical solder paste due to solder flow away.

3.6 Reflow profile

Figure 14. ST ECOPACK[®] recommended soldering reflow profile for PCB mounting



Note: Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.



4 Ordering information

Figure 15. Ordering information scheme

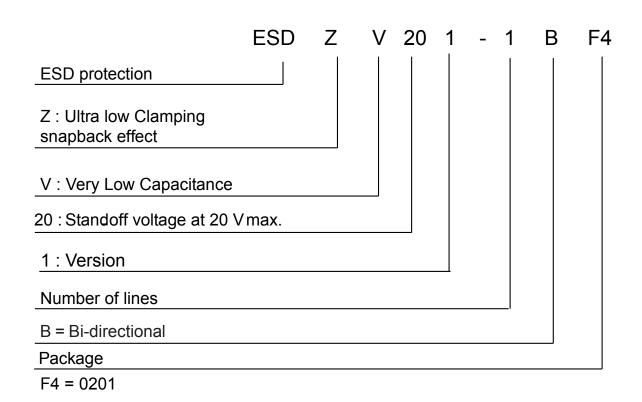


Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
ESDZV201-1BF4	J	0201	0.072 mg	15000	Tape and reel

1. The marking codes can be rotated by 90° or 180° to differentiate assembly location.

Revision history

Table 5. Document revision history

Date	Revision	Changes
07-Jan-2020	1	Initial release.



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